	No. 5 Ring Ros	ad LISP II, Brgy. I	GE PHILIPPINE INC. La Mesa, Calamba City, Laguna	INVESTIGATION REPORT FORM (IRF)				
	Fax No. (049)	. (049) 545-7166 t 545-6302	0 69	Inhouse Detection Control No.: 297	Date Issued:	comer Claim		
Custor	ner	SANYO DENI	ζ1 —	Attention To	Mr. Gerald De Guzman	20 09 19		
Item C	ode	00415456-01		Department	PRODUCTION			
Item D	escription	PACKAGE	2	Date of Detection	20 09 17			
Job O	der Number	WO-DRS-20-	M-01194-167	Section Detected QA - IN LINE				
	ILL	USTRATION O	F THE PROBLEM	Major	Minc	DF .		
N-10	5-1	INKI		Lot Quantity (pcs.)	Reject Quantity (pcs.)	Reject Percentage		
				1,498	30	2.00%		
7/				Nature of Defect:				
	· · · · · · · · · · · · · · · · · · ·			GLUE STAIN				
lio	plnes		CARD BOARD	Requirement:				
			PET A SEE	No glue stain on the surface of the item				
	 -			Actual:				
					W/ glue stain			
	NO. OF OCCURRE	ENCE	DISPOSITION	AREA OF OCC	CURRENCE / ORIGIN	CONTENT		
	First		Hold	Slotter	Gluing	Material		
	Recurrence		Special Acceptance	EQOS	Vertical	Dimension		
	No.:		For Rework	Diecut	Others:	Appearance		
	Date:		Reject / Disposal	Detaching		_ Process / Method		
	Issued by		Checked by	Approved	by	Received by (Receiving Section)		
	Adrian Vergara QA-IE Staff		Mg. Noemi Cepeda QA-Supervisor	Mr. Rexel All QA Asst. Mar		Gerard De Guzman Head/Supervisor		
h, etc.			I. INVESTIGAT	ION / ANALYSIS				
	DIRECT CAUSE: (An	alyze the reaso	on of occurrence, why it happened?)	INDIRECT CAUS	E: (Analyze the reason of occu	rrence, why it leaked?)		
D.	Why 1:			Why 1:				
System / Training	Why 2:	. \		Why 2:				
tem /	Why 3:	17/	A	Why 3:	P/A			
Syst	Why 4:			Why 4:				
	Why 5:			Why 5:				
Design / Toolings	Why 1:			Why 1:				
	Why 2: Why 3:			Why 2: Why 3:	N/A			
	Why 4:	. /	A	Why 4:	, , ,			
De	Why 5:			Why 5:				
	Why 1:			Why 1:				
terial	Why 2: Why 3: PLS. SEE ATTACHED Why 4:			Why 2:				
Process / Material				Why 3: PLS. SEE ATTACHED				
				Why 4:	A 1/AUTE	- 1		
P	Why 5:			Why 5:				

KANEPACKAGE PHILIPPINE INC.

No. 5 Ring Road LISP II, Brgy. La Mesa, Calamba City, Laguna Telephone No. (049) 545-7166 to 69 Fax No. (049) 545-6302

INVESTIGATION REPORT FORM (IRF)

FINAL CONCLUSION								
	C	OCCURRENCE ROOTCA	USE		OUTFLOW ROOTCAUSE			
l	LEAK O	of GLUE APP	HCATOR	THE MARIC OF GLUE DIDN'T NEMOVE				
IMMEDIA	TE ACTION: (A	ction to be done to contain/ ter	nporary correct the pro	CORRECTIVE ACTION: (Actions to be done to ensure that the problem will not happen again)				
A. Sorting Resu	ult				Actions to be done to eliminate recurrence Who / When			
	Loca	ation Total Sto	ock NG	Total Good		N/A		
RM	N/	A			System			
WIP	N	/A						
FG	NI	A						
B. Orientation								
Date	N	A Time	1/1	A	Design /	P/A		
Title		N/A	N/A			I'/A		
, indees		NIP						
C. Reworking					Process			
Rework Quan	tity	1	1/A			PLS. SEE ATTACHED		
Total Good		ŀ	1/A	re-Elline's				
Rework Perce	entage (Good)	K	I/A					
II. QA R	OOTCAUSE	/ERIFICATION (To be fil	ed out by QA In-	charge)	Date Conducted: 20 09 21 PIC: A-Vergara			
		Identified Rootcause		Recommendation				
> The glue drip on the surface of the boards, because it was leak from the glue applicator. The glue applicator copper head overheats.						> Clean the copper head > Standardize the frequency of cleaning copperhead		
III. CORRECTIVE ACTION VERIFICATION (To be filled out by QA In-charge)								
		Checked by	Date	Implen	nented?	Remarks	T	
1st Verification of Action		A. Vergara	20 09 25	[/] Yes	[] No	C.A. is implemented		

Checked by Date Implemented? Remarks

1st Verification of Action A. Vevgava 20 09 25 If yes I No C.A. is implemented

2nd Verification of Action I yes I No

Effectiveness of Action A. Vevgava 20 11 14 If yes I No C.A. is effective

Note: If no same defects / problems occurs for 5 consecutive deliveries, corrective action is considered effective / closed. If the same problem occurs within 5 consecutive deliveries or 3rd verification of action still not yet implemented, Investigation Report shall be re-issued to the affected department to provide new improvement action.

E AND	ALITY	ACCUE	MIARE	ACEDA DO	WENT	IV. CL	OSURE		
ius:	41111	HOODIN	ANUE L	JEPAN	MEIVI	Appro	oved by:	Process Owner Acknowled	dgment: (Receiving Section)
Clo ed Stil Open						W244- Supervisor	QA/ASel Manager	Line Leader	Department Head
Re-Issue IRF					Date:	210111	Date: 2 0 1	Date: 21 01 11	Date: 21 01 1
SIGNATURE 210109									

INVESTIGATION REPORT FOR GLUE STAIN OF SANYO DENKI 00415456-01 PACKAGE

	W1 - Possible glue stain happened due to leak glue from the glue applicator.				
DINECT CAOSE	W2 - Due to mechanism of glue applicator the glue applicator copper head got overheat that cause of dried glue.				
	W3 - Dried glue accumulated in the roller of glue applicator that caused leak glue.				

INDIRECT
CAUSE
PROCESS/MATERIAL

W1- Operator try to wipe out the glue stain in the box but the mark of glue didn't remove.

PRODUCTION CORRECTIVE ACTION

The overheating of glue applicator copper head is inherent due to its mechanism, why the corrective action of roduction is to standard the cleaning of glue applicator after 6hrs of operation and before the end of the shift. Totally glue applicator clean twice per shift and once they encounter leak glue before the standard time set, operator need to immediately report the abnormality happen to Leader in-charge.

PIC:	PRODUCTION	TARGET DATE:	200925

PREPARED BY:

GERALO DE GUZMAN PROD ASST. SUPERVISOR **APPROVED BY:**

VEENA V. APALLA SR. SUPERVISOR

200922